Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

This Assembly Note will show in the PcbDoc and associated outputs

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE

<table>
<thead>
<tr>
<th>BOARD #:  TIDA-01250</th>
<th>REV:  E1</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td>TID #: TIDA-01250</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

PLOT NAME = Top Assembly Drawing

GENERATED: 6/30/2017 11:51:41 AM

TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA-01250</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td>TID #: TIDA-01250</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 6/30/2017 11:51:43 AM</td>
<td></td>
<td>TEXAS INSTRUMENTS</td>
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